

CEPF630/CEBF630

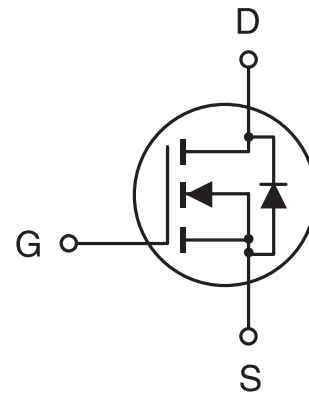
March 1998

N-Channel Enhancement Mode Field Effect Transistor

4

FEATURES

- 200V , 10A , $R_{DS(ON)}=400m\Omega$ @VGS=10V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220 & TO-263 package.



ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous -Pulsed	I_D	10	A
	I_{DM}	40	A
Drain-Source Diode Forward Current	I_S	10	A
Maximum Power Dissipation @ $T_c=25^\circ\text{C}$ Derate above 25°C	P_D	75	W
		0.6	W/ $^\circ\text{C}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.5	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$

CEPF630/CEBF630

4

ELECTRICAL CHARACTERISTICS (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	200			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =160V, V _{GS} =0V			25	μA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS^a						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2	2.9	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		265	400	mΩ
On-State Drain Current	I _{D(ON)}	V _{GS} =10V, V _{DS} =10V	10			A
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =5A	3	6		S
DYNAMIC CHARACTERISTICS^b						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V f=1.0MHz		646	800	pF
Output Capacitance	C _{OSS}			105	140	pF
Reverse Transfer Capacitance	C _{RSS}			36	50	pF
SWITCHING CHARACTERISTICS^b						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =100V, I _D =5A, V _{GS} =10V, R _{GEN} =50Ω		50	60	ns
Rise Time	t _r			80	120	ns
Turn-Off Delay Time	t _{D(OFF)}			55	80	ns
Fall Time	t _f			40	50	ns
Total Gate Charge	Q _g	V _{DS} =160V, I _D =5.9A, V _{GS} =10V		25	60	nC
Gate-Source Charge	Q _{gs}			5		nC
Gate-Drain Charge	Q _{gd}			7		nC